# THROUGH-HOLE LOW PROFILE HEADE

(2.00 mm) .0787" PITCH • TMM SERIES



**TMM Board Mates:** 

CLT, SQT, SQW, ESQT, TLE, SMM, MMS

**Cable Mates:** 

**TCSD** 

#### **SPECIFICATIONS**

Insulator Material: Black Liquid Crystal Polymer
Terminal Material: Phosphor Bronze Plating:

Sn or Au over 50 μ" (1.27 μm) Ni **Operating Temp Range:** -55 °C to +105 °C with Tin; -55 °C to +125 °C with Gold

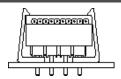
Current Rating (SMM/TMM): 3.3 A per pin (2 pins powered)

Voltage Rating: 281 VAC/397 VDC mated with SQW; 250 VAC/354 VDC mated with SQT 375 VAC/530 VDC mated with SMM

#### **PROCESSING**

Lead-Free Solderable:

#### **APPLICATION**



Retention Clip Option (-RC)

**ALSO AVAILABLE** 

Other Platings



Some lengths, styles and options are non-standard, non-returnable.



NO. PINS PER ROW

02 thru 50

## LEAD **STYLE**

Specify LEAD **STYLE** from chart

#### **PLATING OPTION**

= Gold flash on post, Matte Tin on tail

= 10 μ" (0.25 μm) Gold on post, Matte Tin on tail

> -Т = Matte Tin

-F

#### ROW **OPTION**

-S = Single Row

-D = Double Row

> Q-= Four Row

## -RA &

**OPTION** 

-RE = Right-angle (Lead Style –01 only) (2 positions minimum, -Q row)

## -RC

= Retention Clip (Mates with TCSD) (Double row only, 4 positions minimum, only available –06 lead style)

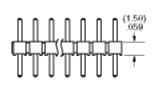
#### -"XXX"

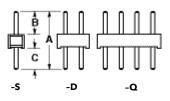
= Polarized Position (Specify position of omitted pin)

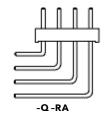












	-
-RC	

OPTION	D
–RA	(1.27) .050
–RE	(3.56) .140

-RA & -RE

LEAD STYLE	A	В	С
-01	(8.20) .323	(3.20) .126	(3.50) .138
-02		(3.70) .146	(3.00) .118
-03		(4.00) .158	(2.70) .106
-04	(5.69) .224	(1.91) .075	(2.29)
-05	(5.43) .214	(1.65) .065	
-06	(9.58) .377	(3.20) .126	(4.88) .192